



Attorney's Docket No.: 042390.P15858

Patent  
**RESPONSE UNDER 37 C.F.R. § 1.116**  
**EXPEDITED PROCEDURE**  
**EXAMINING GROUP 2826**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of: )  
)  
Vassoudevane Lebonheur, et al. )  
) Examiner: Victor A. Mandala  
Application No: 10/612,764 )  
) Art Unit: 2826  
Filed: June 30, 2003 )  
)  
For: MOLD COMPOUND CAP IN A )  
FLIP CHIP MULTI-MATRIX ARRAY )  
PACKAGE AND PROCESS OF )  
MAKING SAME )  
\_\_\_\_\_ )

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE AFTER FINAL ACTION  
UNDER 37 C.F.R. § 1.116

Dear Sir:

In response to the Office Action dated April 6, 2007, Applicants respectfully request that the above-identified application be amended as follows and that the following remarks be considered:

FIRST-CLASS CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail with sufficient postage in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia, 22313-1450, on:

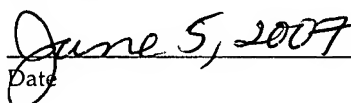
June 5, 2007

Date of Deposit

Ariana C. Bates

Name of Person Mailing Correspondence

  
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Vassoudevane Lebonheur, et al.  
Application No.: 10/612,764

Examiner: Victor A. Mandala  
Art Unit: 2826